# WS2816B-2020



16Bit 3 Channel Constant current digital LED breakpoint continuous transmission LED light source

#### **General description**

Worldsemi New generation digital led is specially designed for high resolution display application, each channel with 16bit gray scale, 4bit gamma correction inside, can achieve 20bit display effect. With 10KHZ Port refresh frequency.

High-tech integrated digital led, no need any external components including capacitor;

Dual input and output signals, automatic switching to ensure reliability;

The data transfer protocol use single NZR communication mode. After the pixel power-on reset, the DIN port receive data from controller, the first pixel collect initial 48bit data then sent to the internal data latch, the other data which reshaping by the internal signal reshaping amplification circuit sent to the next cascade pixel through the DO port. After transmission for each pixel, the signal to reduce 48bit. Pixel adopt auto reshaping transmit technology, making the pixel cascade number is not limited the signal transmission, only depend on the speed of signal transmission.

#### **Features and Benefits**

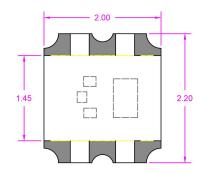
- The control integrated circuit and the LED share the only power source.
- Control circuit and RGB chip are integrated in a package of 2020 components, to form a complete addressable pixel.
- Built-in signal reshaping circuit, after wave reshaping to the next driver, ensure wave-form distortion not accumulate.
- Built-in electric reset circuit and power lost reset circuit.
- OUT R / G / B output gray level: R,G,B 65536 gray scale(Built-in 4Bit GAMMA correction).
- Port with 10KHz refresh frequency.
- Cascading port transmission signal by single line.
- 2.2mm\*2.0mm\*0.84mm,Super tiny size

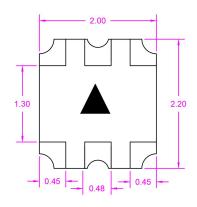
#### **Applications**

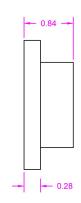
•LED transparent screen, LED pixel screen, LED special-shaped screen, various electronic products.



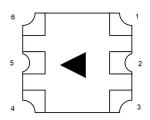
# Mechanical Dimensions (Unit:mm)

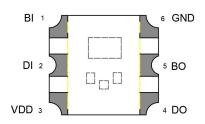


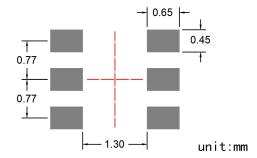




## **PIN Configuration**







Recommended pad size(Unit: mm)

## **PIN Function**

NO.	Symbol	PIN	Function description
1	BI	Secondary DATA IN	Secondary data in PIN
2	DI	DATA IN	Control data signal input
3	VDD	POWER SUPPLY	Power supply
4	DO	DATA OUT	Control data signal output
5	ВО	Secondary DATA OUT	Secondary data out PIN
6	GND	GROUND	Ground, data & power grounding

# Absolute Maximum Ratings (TA=25 $^{\circ}\text{C}$ ,VSS=0V)

Parameter	Symbol	Ratings	Unit
Power supply voltage	$ m V_{DD}$	+3.7~+5.5	V
Logical Input Voltage	$V_{\rm I}$	-0.3V~VDD+0.7	V
Quiescent Current	$I_{\mathrm{DD}}$	< 0.8	mA
Operation junction temperature	Topt	-25~+85	$^{\circ}\! \mathbb{C}$
Storage temperature range	Tstg	-40~+105	$^{\circ}$ C



## Electrical Characteristics ( $T_A=25^{\circ}\text{C}$ , $V_{DD}=5V$ , $V_{SS}=0V$ )

Parameter	Symbo	Min	Тру	Max	Unit	Conditions
Port output current	Iout		20		mA	OUTR+OUTG+OUTB
Input Current	$I_{\rm I}$			±1	μА	$V_I = V_{DD}/V_{SS}$
High-level input voltage	V <sub>IH</sub>	$0.7V_{DD}$			V	
Low-level input voltage	V <sub>IL</sub>			0.3 V <sub>DD</sub>	V	
Hysteresis voltage	$V_{\mathrm{H}}$		0.35		V	
Dynamic current consumption	IDDdyn		0.7	1	mA	OUTR,OUTG,OUTB =OFF DO=open circuit
Power consumption	PD			250	mW	Ta=25℃
Signal output sink current	Iodo			45	mA	

# Switching Characteristics ( $T_A=25$ °C, $V_{DD}=5V$ , $V_{SS}=0V$ , unless otherwise specified)

Parameter	Symbol	Min.	Тур.	Max.	Unit	Test Condition (Working current)
Transmission delay time	$t_{PLZ}$			300	ns	CL=15pF, DIN→DOUT, RL=10KΩ
Fall time	t <sub>THZ</sub>			120	μs	CL=300pF, OUTR/OUTG/OUTB
Input capacity	Cı			15	pF	

#### **LED Characteristics**

Parameter	Symbol	Color	Te	est Condition	n: VDD=5V	7
1 ur umeter	~ J 111 01		Min.	Тур.	Max.	Unit
		Red	210	285	360	
Luminous	IV	Green	400	520	650	mcd
intensity	l V	Blue	70	90	120	ilicu
		Red	620	623	625	

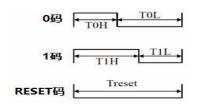


Wavelength	λd	Green	522	525	527	nm	
		Blue	467	469	472		
			-	0.30	-	/	
Color	C	ΙE		0.33		/	
Coordinate			-	0.33	-	/	
Luminous	Θ	1/2	-	120	-	Deg	
Angle							

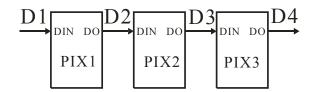
#### **Data Transfer Time**

ТОН	0 code, high voltage time	200ns~320ns							
T1H	1 code, high voltage time	520ns~800ns							
TOL	0 code, low voltage time	800ns~1.2μs							
T1L	1 code, low voltage time	480ns-1μs							
RES	RES Frame unit, low voltage time >280μs								
Data Cycle: T0H+TOL≥1.25μs ; T1H+T1L≥1.25μs									

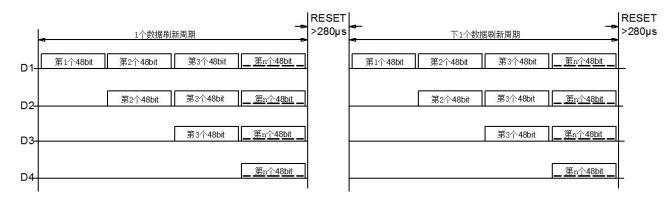
# Timing waveform diagram Sequence Chart



#### Cascade Method:



#### **Data Transmission Method**



Note: The data of D1 is send by MCU, and D2, D3, D4 through pixel internal reshaping amplification to transmit.



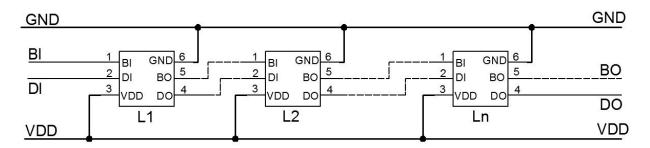


#### **Composition of 48bit Data**

G15	5 G14	G13	G12	G11	G	10	G9	G8	G7	G6	G5	G4	(	G3	G2	G1	G0	…接↑	F
								_								_			
	··接上···	R15	R14	R13	R12	R11	R10	R9	R8	R7	R6	R5	R4	R3	R2	R1	R0	•••接↑	F
	··接上···	B15	B14	B13	В	12	B11	B10	В9	В8	В7	E	36	В5	В4	В3	B2	B1	В0

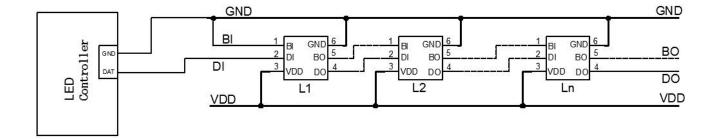
Note: Data transmit in order of GRB, high bit data at first.

#### **Typical Application Circuit**



The peripheral circuit don't need to add filter capacitor.

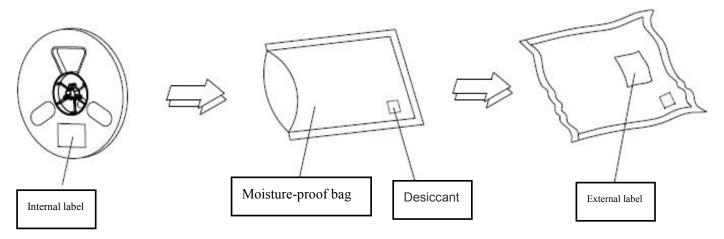
Signal wiring diagram: The first LED BI is connected to GND



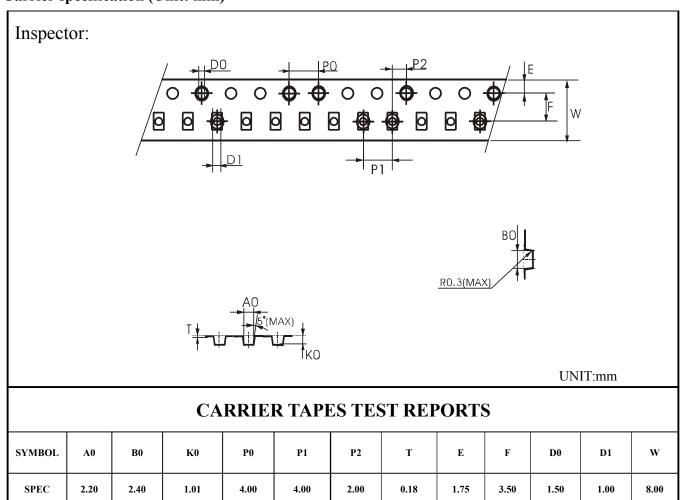




# Packaging method

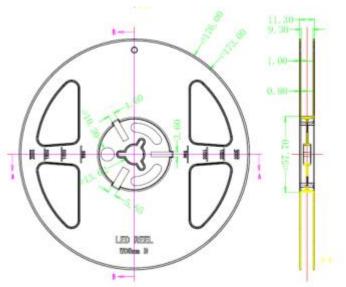


#### Carrier specification (Unit: mm)





#### **Reel Packing Specifications (Unit: mm)**



# **Top SMD LED Using Instructions**

#### 1. Summary

To make the best use of WORLDSEMI's LED, please refer to the below precautions, they are of same usage method as other electronic components.

#### 2. Cautions

#### 2.1. Dust & Cleaning

The surface of the LED is encapsulated with modified epoxy resin because it plays a very good role in protecting the optical performance and aging resistance. The modified epoxy resin is easy to stick with dust and must be kept clean. When there's a certain amount of dust on the surface of the LED, it won't affect brightness, but dust proof should be taken care of. Promoting the use of unsealed package in preference to others and the assembled LEDs should be placed in a clean container.

Tabel I - IPC/JEDEC J-STD-020 Moisture/Reflow Sensitivity Classification

MSL Level		Workshop Life
WISE Ecvel	Time	Conditions
LEVEL1	Unlimited	≤30°C/85%RH
LEVEL2	1 Year	<30°C/60%RH





LEVEL2a	4 Weeks	≤30°C/60%RH
LEVEL3	168 Hours	≤30°C/60%RH
LEVEL4	72 Hours	≤30°C160%RH
LEVEL5	48 Hours	≤30°C/60%RH
LEVEL5a	24 Hours	≤30°C/60%RH
LEVEL6	Take-out and Use immediately	≤30°C/60%RH

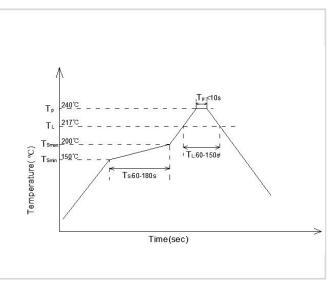
#### 2.3 SMT requirements

- 2.3.1 It is recommended to unpack the LED before SMT and put the whole roll in the oven for dehumidification and drying  $(70\sim75^{\circ}\text{C baking} \ge 24\text{H})$ ;
- 2.3.2 The product is taken out from the oven to the completion of high-temperature soldering (including multiple reflow soldering, immersion tin, wave soldering, heating maintenance and other high-temperature operations/operations), the time period is controlled within 24 (under T $<30^{\circ}$ C, RH<60% conditions);
- 2.3.3 After the LED is attached to the PCBA after printing the solder paste, the SMT should be completed as soon as possible, and it is recommended not to exceed 1H;
- 2.3.4 Bulk LEDs such as production surplus, machine throwing materials, maintenance materials, etc., should not be used directly if they are exposed to the air for a long time. It is recommended to use them after dehumidification and drying. Whole roll baking:  $70\sim75^{\circ}\text{C*} \geq 24\text{H}$  or bulk baking:  $120^{\circ}\text{C} \approx 4\text{H}$ .

#### 3. SMT Reflow

Refer to the parameters listed below, the experimental results prove that the TOP SMD LED meets the JEDEC J-STD-020C standards. As a general guideline, it is recommended to follow the SMT reflow temperature curve recommended by the solder paste manufacturer.

<b>Curve Description</b>	Lead-free
The lowest preheat temperature (Tsmin)	150℃
The highest preheat temperature (Tsmax)	200℃
Preheating time (Tsmin to Tsmax) (ts)	60-180 S
Average rate of temperature rise (Tsmax to Tp)	<3°C/S
LIQUID REGION temperature (TL)	217℃
LIQUID REGION Holding Time (tL)	60-150 S
Peak Temperature (Tp)	240℃
High Temperature Region(Tp=-5°C) Holding	<10 S
Cooling Rate	<6°C/S
Room Temperature to Peak Holding Time	<6 min



Remarks: 1. These general guidelines may not apply to all PCB designs and reflow soldering configurations.

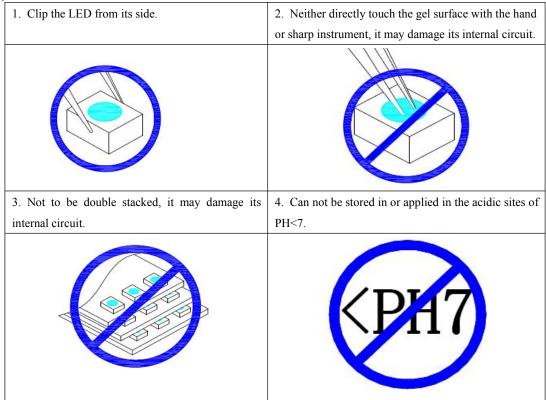


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2. All temperatures referred are measured on the surface of the package body.

#### 4. Assembly Precautions



#### **Modify Record**

Version №	Status Bar	<b>Modify Content Summary</b>	Date	Reviser	Approved
V1.0	N	New-Official release	20201206	Shen JinGuo	Yin HuaPing